

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1528	(438/455).CCLS.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2007/09/25 14:16
L2	1	L1 and (metal near4 metal adj bond\$4).clm.	US-PGPUB	OR	ON	2007/09/25 14:17
L3	11	L1 and ((bond\$4 near3 (metal conductor)) same (first adj (substrate wafer)) same (second adj (substrate wafer))).clm.	US-PGPUB	OR	ON	2007/09/25 14:23
L4	1	("6762076").PN.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2007/09/25 14:23
S1	18463	wafer near3 bond\$3	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:40
S2	1	("20040157407").PN.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2007/09/15 13:40
S3	1522	(438/455).CCLS.	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	OFF	2007/09/25 14:14
S4	1047	S3 and (@ad<"20030630" @rlad<"20030630")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:55
S5	579	S1 and S4	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:43
S6	372	S1 and (island with (metal conductor conductive))	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:46
S7	278	S6 and (@ad<"20030630" @rlad<"20030630")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:46
S8	113330	(wafer substrate) near3 bond\$3	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:55

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S9	89776	S8 and (@ad<"20030630" @rlad<"20030630")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 14:07
S10	993	S9 and (island with (metal conductor conductive))	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 13:56
S11	16	S10 and S3	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 14:00
S12	160	S10 and (((bond\$3 land\$3) near2 pad) with (metal conductor conductive))	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 14:04
S13	3601	(solder adj (bump ball)) same (((bond\$3 land\$3) near2 pad) with (metal conductor conductive))	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 14:07
S14	2897	S13 and (@ad<"20030630" @rlad<"20030630")	US-PGPUB; USPAT; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 14:08